

Title (en)
NTC CERAMIC PART, ELECTRONIC COMPONENT FOR INRUSH CURRENT LIMITING, AND METHOD FOR MANUFACTURING AN ELECTRONIC COMPONENT

Title (de)
NTC-KERAMIK, ELEKTRONISCHES BAUELEMENT ZUR EINSCHALTSTROMBEGRENZUNG UND VERFAHREN ZUR HERSTELLUNG EINES ELEKTRONISCHEN BAUELEMENTS

Title (fr)
CÉRAMIQUE À CTN, COMPOSANT ÉLECTRONIQUE DE LIMITATION DU COURANT DE MISE SOUS TENSION ET PROCÉDÉ DE FABRICATION D'UN COMPOSANT ÉLECTRONIQUE

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Application
EP 16822388 A 20161213

Priority
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Abstract (en)
[origin: WO2017102724A1] The invention relates to an NTC ceramic part for use in an electronic component (10) for inrush current limiting, the NTC ceramic part having an electric resistance in the mΩ range at a temperature of 25°C and/or at room temperature. The invention further relates to an electronic component (10), a method for manufacturing an electronic component (10), and a system (200) comprising at least one electronic component (10).

IPC 8 full level
H01C 7/04 (2006.01)

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DE 102015121982 A 20151216; CN 201680073955 A 20161213; CN 202110325284 A 20161213; EP 16822388 A 20161213; EP 2016080789 W 20161213; JP 2018531539 A 20161213; JP 2020109747 A 20200625; KR 20187019223 A 20161213; TW 105141592 A 20161215; US 201616063266 A 20161213